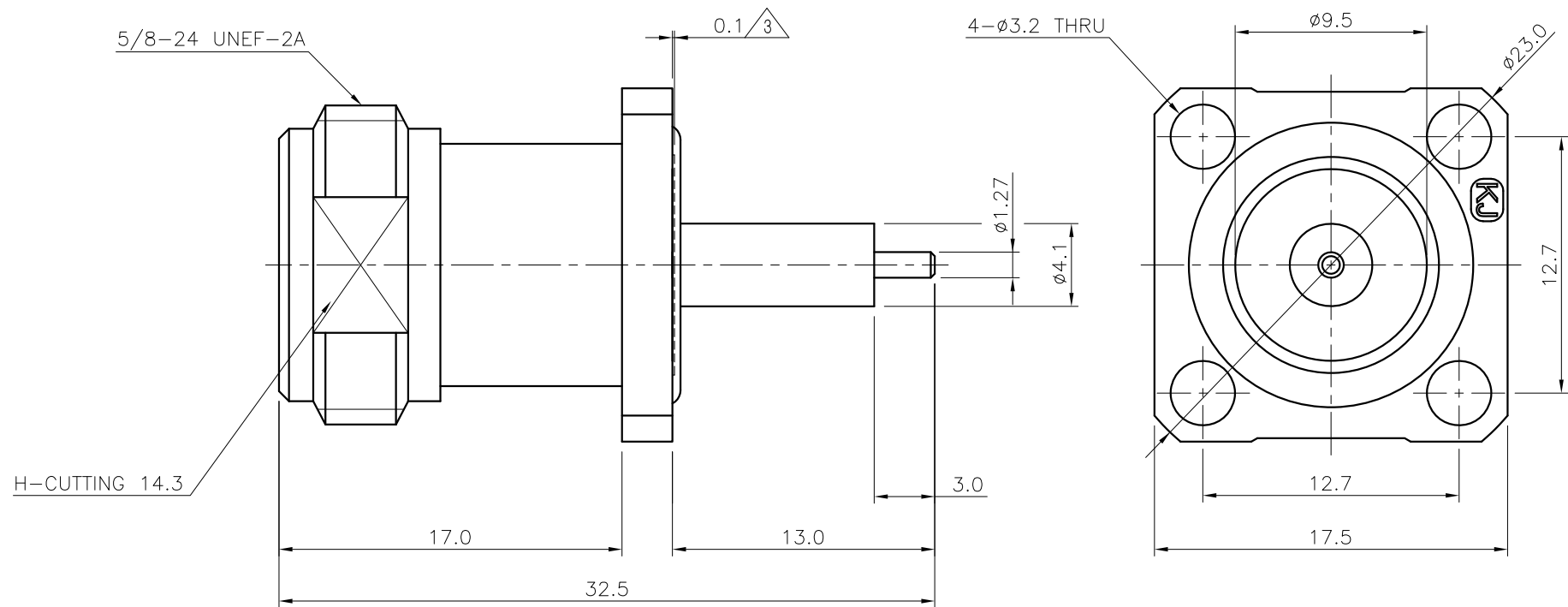


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.10.26.
1	[설변No.201907-0003] 가스켓 이탈 방지로 인한 가스켓 변경	S.Y.EUN	I.C.KIM	2019.07.02.
2	[설변No.202012-0002] O-RING 빠짐 개선 안착부 금형수정	I.C.KIM		2020.12.07.
3	[설변No.202101-0003] O-RING 빠짐 개선 안착부 0.1mm Ground Boss 추가	S.Y.EUN	I.C.KIM	2021.01.20.
4	RING 억지끼움후 돌출부위 감안하여 길이 조정	S.H.KIM		2024.11.08.



4 3 2		1	5	GASKET	1	SILICONE RUB	RED	DGK00257-N/2 DGK00032-N/1	
			4	RING	1	MBsBD C3604BD-F	Nickel Plate	DSR01097-5/4 DSR01097-5/3	
			3	INSULATOR	1	TEFLON		DIN02840-N/5	
			2	CONTACT	1	BeCu C17300	Silver Plate (3μm)	DCT03741-5/3	
		2	1	BODY	1	ZnDC	Nickel Plate (3~4μm)	DBD02992-5/3 DBD02992-5/1	
			NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	
TOLERANCE		Decimal	DATE			KJ  COMTECH KJ COMTECH CO.,LTD.			
		±0.2	2024. 11. 08.						
		Angle	APPROVED BY				TITLE		
		±1°	CHECKED BY						
MATERIAL		DRAWN BY		S.H.KIM		N50 SOLDER END JS-4H			
FINISH		SCALE		UNIT					
		3/1		mm		A4 DWG NO. CN03958-7/5			
						REVISION		SHEET	
						4		1 of 1	